



Connectors > PCB Connectors > Backplane Connectors > High Speed Backplane Connectors



Number of Positions: 192
Row-to-Row Spacing: 1.4 mm [.055 in]
Mating Alignment: With
Mating Alignment Type: Guide Slot
Number of Rows: 12

Features

Product Type Features

Signal Arrangement	Differential
Connector System	Board-to-Board
Connector & Contact Terminates To	Printed Circuit Board
PCB Connector Assembly Type	PCB Mount Header
Shroud Style	Fully Shrouded

Configuration Features

Pairs per Column	4
Number of Pairs	64
Stackable	No
Number of Signal Positions	128
Backplane Architecture	Traditional Backplane
Number of Positions	192
Number of Rows	12
Number of Columns	16
PCB Mount Orientation	Vertical

Electrical Characteristics

Impedance	100 Ω
Operating Voltage	250 VAC



Signal Characteristics

Differential Impedance	100 Ω
Number of Differential Pairs per Column	4
Data Rate	10 Gb/s

Body Features

Primary Product Color	Black
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Contact Features

Contact Mating Area Length	6 mm[.236 in]
PCB Contact Termination Area Plating Material Thickness	.5 μm[20 μin]
Contact Type	Pin
Contact Mating Area Plating Material Thickness	.76 μm[29.92 μin]
Contact Mating Area Plating Material	Gold
PCB Contact Termination Area Plating Material Finish	Matte
Contact Shape & Form	Rectangular
PCB Contact Termination Area Plating Material	Tin
Contact Base Material	Phosphor Bronze
Contact Current Rating (Max)	.5 A

Termination Features

Termination Post & Tail Length	2.5 mm[.098 in]
Termination Method to PCB	Through Hole - Press-Fit

Mechanical Attachment

Guide Hardware	Without
Mating Retention	Without
PCB Mount Alignment	Without
PCB Mount Retention	With
PCB Mount Retention Type	Action/Compliant Tail
Mating Alignment	With
Mating Alignment Type	Guide Slot
Connector Mounting Type	Board Mount

Housing Features

Number of Shrouded Sides	4
End Wall Location	Dual



Housing Material	LCP (Liquid Crystal Polymer)
Centerline (Pitch)	1.9 mm[.075 in]

Dimensions

Connector Length	11.8 mm
Connector Height	11.8 mm
Connector Width	20.2 mm
PCB Hole Diameter	.47 mm
Row-to-Row Spacing	1.4 mm[.055 in]

Usage Conditions

Operating Temperature Range	-65 – 90 °C[-85 – 194 °F]
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Operation/Application

Circuit Application	Signal
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Industry Standards

Compatible With Agency/Standards Products	UL
Compatible With Approved Standards Products	UL E28476
UL Flammability Rating	UL 94V-0

Packaging Features

Packaging Method	Box & Tube, Tube
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Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2024 (241) Candidate List Declared Against: JUNE 2024 (241) Does not contain REACH SVHC
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Not applicable for solder process capability

Product Compliance Disclaimer



This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: <https://echa.europa.eu/guidance-documents/guidance-on-reach>

Compatible Parts

TE Part # 1934225-1
Tin Man Recept Assy 4 Pair 16 Column

Also in the Series | Z-PACK TinMan

High Speed Backplane Connectors(65)

Customers Also Bought

TE Part #1888247-1
20 POS SMT CONN, SFP/SFP+, 30A

TE Part #2-1761603-7
IDC LOW PRO HDR 20P VERT BLUE

TE Part #173926-1
4 P ACTION PIN UMNL

TE Part #5-147377-2
20 SYS50 SMT HDR DR SHD SN



TE Part #5558342-1
MJ,8POS,R/A,CAT5,SHLD,PC GND

TE Part #826629-3
3P AMPMODU II

TE Part #1934306-1
Tin man Header Assy 4x8 Double

TE Part #1410142-2
MULTIGIG RT T2 .8" BP FULL RGH

TE Part #1410186-2
MULTIGIG RT T2 .8" BP HALF LEFT

Documents

Product Drawings

Tin Man Header Assy 4x16 Double

English

CAD Files

Customer View Model

ENG_CVM_1934316-1_B.3d_igs.zip

English

Customer View Model

ENG_CVM_1934316-1_B.3d_stp.zip

English

Customer View Model

ENG_CVM_1934316-1_B.2d_dxf.zip

English

3D PDF

English

By downloading the CAD file I accept and agree to the [Terms and Conditions](#) of use.

Datasheets & Catalog Pages

High Speed Backplane Connectors catalog - Z-PACK TinMan High Speed, High Density Backplane Connector

English

Z-PACK TinMan High Speed High Density Backplane Connector Catalog 5-1773447-9

English

Product Specifications

Application Specification

English

1934316-1

192 Position, Mating Alignment, Guide Slot Mating Alignment Type, 12 Row, 16 Column, PCB Mount Header, Z-PACK TinMan, High Speed Backplane Connectors

